



TECHIE Camp

A TECH CORPS Signature Program



LEONARD GELFAND
STEM CENTER

Register Now!

In partnership with the Leonard Gelfand STEM Center, TECH CORPS will host two (2) Open Enrollment Techie Camps during the summer of 2017.

Techie Camp is a full-day, week-long technology experience designed specifically for elementary and middle school students. The goal of Techie Camp is to engage students in activities that can stimulate a deeper interest in technology; as well as provide opportunities for them to express their imaginations.

Each camp is comprised of 20 students and lead by two TECH CORPS Instructors. Families will be responsible for transportation and lunch/two snacks/beverages. Camps will be held at Case Western Reserve University.

Camps will fill up fast!

Registration Link: <http://bit.ly/2017techiecamp>

Cost: \$325

Techie Camp Topics

Programming	Through fun and engaging experiences with Scratch (elementary) or Unity (middle school), students will learn the basic concepts of programming through the creation of video games and interactive stories.
3D Printing	Students will learn how to use 3D modeling software to design, create, and print various 3D models. The camp will encourage students to think about the real-world implications of 3D printers while also fostering their creativity.

Techie Camp Details				
Dates	Time	Grades	Topic	Location
July 24 th — July 28 th	9:00am— 4:00pm	3 rd - 5 th	ES Programming	Case Western Reserve University
July 24 th — July 28 th	9:00am— 4:00pm	6 th - 8 th	MS 3D Printing	Case Western Reserve University

Registration Process:

Parents can register their students through our online process. Payment will need to be received to confirm registration. Each Techie Camp has a capacity of 20 students. Registration is on a first come, first serves basis.

TECH CORPS Contact:

Please contact Alexis Crosby, Northeast Ohio Regional Director with any questions at acrosby@techcorps.org or 216-315-8240 TECH CORPS.